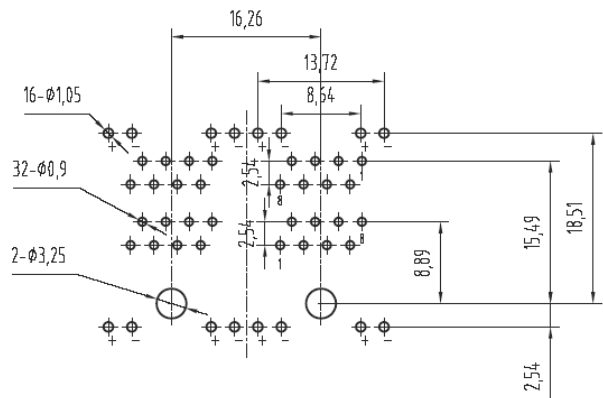
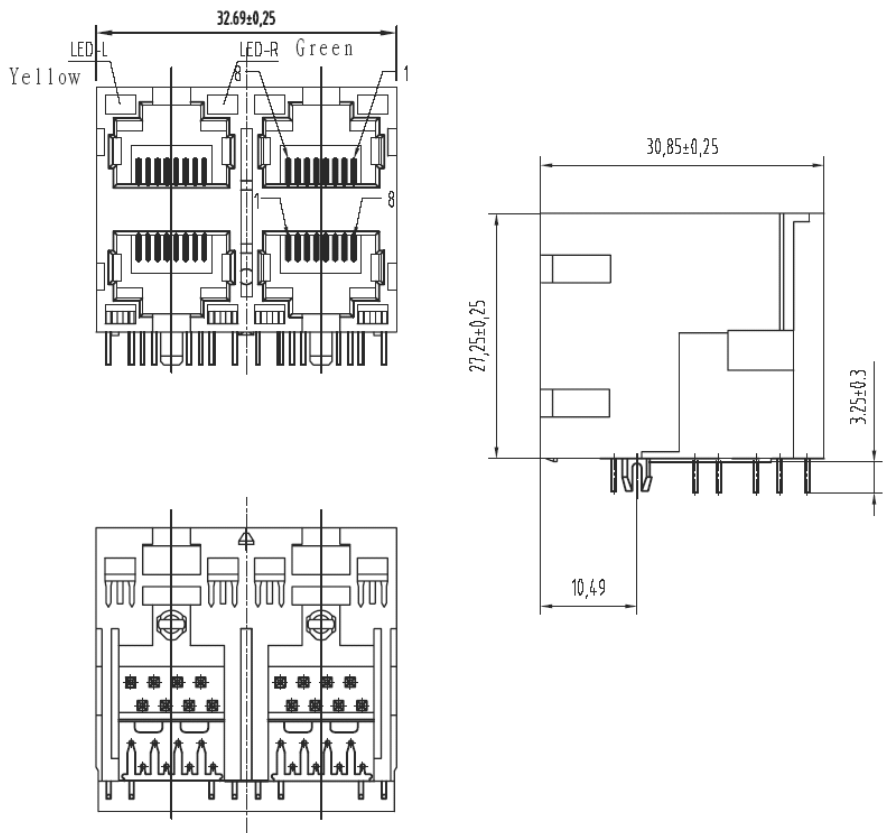


REVISION RECORD				
REV	ECD	DESCRIPTION	DRFT	CHKD



PC Board Layout
Component Side Shown

NOTES:

MATERIAL:

- 1. HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
- 2. CONTACT MATERIAL : PHOSPHOR BRONZE t=0.35mm.
- 3. PLATING : GOLD PLATING 3u"~50u" OVER NICKEL

ELECTRICAL:

- 1. VOLTAGE RATING : 125 VAC RMS.
- 2. CURRENT RATING : 1.5 AMP.
- 3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
- 4. INSULATION RESISTANCE : 500 MEGOHMS MIN @ 500V DC .
- 5. DIELECTRIC WITHSTANDING RESISTANCE : 1000V AC RMS 50Hz. 1MIN.

MECHANICAL:

- 1. DURRABILITY : 750 CYCLES MIN.
- 2. PCB RETENTION PRE-SOLDER : 1 LB MIN.

ENVIRONMENTAL:

- 1. STORAGE : -40° C TO 85° C.
- 2. OPERATION : 0° C TO 70° C.

PART NUMBER:

DETACHED LISTS	MM ← INCH →		DFTO: SHB	DATE: 2007.05.05	HO CHIEN <i>www.hochien.com</i>	
	TOLERANCES EXCEPT AS NOTED		CHKD: LANBO	DATE: 2007.05.05		
			MM	±	MFO:	DATE:
	.0 ± 0.15	±	APPVL:	DATE:	TITLE 5921-8P8C-2X2-LED	
	.00 ± 0.075	±	MATERIAL :			
.000 ± 0.05	±	ANGLES ± 0.5		QT'Y :	DRAWING NO. TE52A1003	SIZE A3
THIRD ANGLE PROJECTION		FINISH :		SCALE :	/PART NO.	REV 0
DO NOT SCALE DRAWING					SHEET OF	